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| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br>( Not for submission under 37 CFR 1.99) | Application Number   |                   | 10797646   |  |
|   | Filing Date          |                   | 2004-03-10 |  |
|   | First Named Inventor | Matthew H. HARPER |            |  |
|   | Art Unit             | 4152              |            |  |
|   | Examiner Name        | B. J. Rubin       |            |  |
| Attorney Docket Number  |                      | 111244.162US1     |            |  |

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